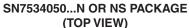


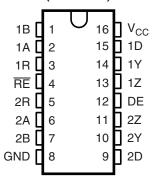
DUAL DIFFERENTIAL DRIVERS AND RECEIVERS

Check for Samples: SN7534050, SN7534051

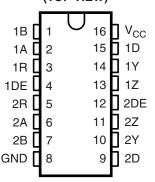
FEATURES

- Meet or Exceed Standards TIA/EIA-422-B and ITU Recommendation V.11
- Operate From Single 5-V Power Supply
- Driver Positive and Negative Current Limiting
- Receiver Input Sensitivity: ±200mV
- Receiver Input Impedance: 12 kΩ Min
- Driver 3-State Outputs
- Receiver 3-State Outputs (SN7534050 Only)





SN7534051...N OR NS PACKAGE (TOP VIEW)



DESCRIPTION

The SN7534050 and SN7534051 dual differential drivers and receivers are monolithic integrated circuits designed to meet the requirements of ANSI standards TIA/EIA-422-B and ITU Recommendations V.11.

The driver outputs provide limiting for both positive and negative currents and thermal shutdown protection from line fault conditions on transmission bus line.

The SN7534050 combines dual 3-state differential drivers and dual 3-state differential input receivers. The drivers and receivers have active-high and active-low enables, respectively which can be externally connected together to function as direction control. SN7534051 drivers each have an individual active-high enable.

ORDERING INFORMATION

T _A	P/	ACKAGE ⁽¹⁾ (2)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN7534050N	SN7534050N
	SOP – NS	Tube of 50	SN7534050NS	SN7534050
2000 4- 0500	30P - N3	Reel of 2000	SN7534050NSR	SN7534050
–20°C to 85°C	PDIP – N	Tube of 25	SN7534051N	SN7534051N
	COD NC	Tube of 50	SN7534051NS	SN7534051
	SOP – NS	Reel of 2000	SN7534051NSR	SN7534051

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

⁽²⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



FUNCTION TABLES

Table 1. SN7534050, SN7534051 Each Driver⁽¹⁾

INPUT	ENABLE	OUT	PUTS
D	DE	Υ	Z
Н	Н	Н	L
L	Н	L	Н
Х	L	Z	Z

H = high level, L = low level,
 X = irrelevant, Z = high impedance (off)

Table 2. SN7534050 Each Receiver⁽¹⁾

DIFFERENTIAL INPUTS, A-B	EN <u>AB</u> LE RE	OUTPUT R
V _{ID} ≥ 0.2 V	L	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	L	?
$V_{ID} \leq -0.2 \text{ V}$	L	L
X	Н	Z

(1) H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

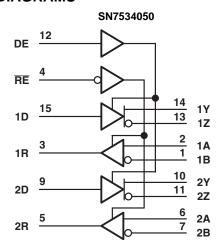
Table 3. SN7534051 Each Receiver⁽¹⁾

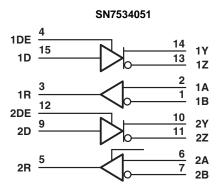
DIFFERENTIAL INPUTS, A-B	OUTPUT R
V _{ID} ≥ 0.2 V	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$?
V _{ID} ≤ -0.2 V	L

(1) H = high level, L = low level, ? = indeterminate

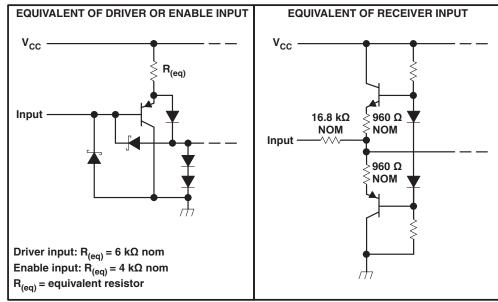


LOGIC DIAGRAMS





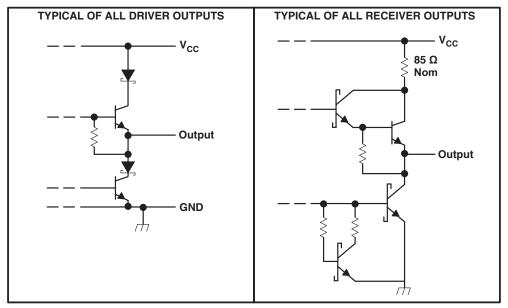
SCHEMATIC OF INPUTS



All resistor values are nominal.



SCHEMATIC OF OUTPUTS



All resistor values are nominal.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage ⁽²⁾			7	V
VI	Input voltage	DE, RE, D inputs		7	V
Vi	Receiver input voltage	A or B inputs		±25	V
V_{ID}	Receiver differential output voltage (3)			±25	V
Vo	Driver output voltage range	-10	15	V	
I_{OL}	Receiver low-level output current			50	mA
0	Dealer at the second instruction of (4)	N package		66	9 C AA7
θ_{JA}	Package thermal impedance (4)	NS package		68	°C/W
	Operating free-air temperature range		-20	85	°C
T _{stg}	Storage temperature range		-65	150	°C
	Lead temperature, 1.6 mm (1/16 in) from o	case for 10 s		260	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ All voltages, except differential input voltage, are with respect to the network GND.

⁽³⁾ Differential input voltage is measured at the noninverting terminal, with respect to the inverting terminal.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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Recommended Operating Conditions

				MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage			4.75	5	5.25	V
V_{IH}	High-level input voltage	DE, RE, D		2			V
V _{IL}	Low-level input voltage	DE, RE, D				8.0	V
V _{IC}	Common-mode input voltage ⁽¹⁾	Receiver				±7	V
V _{ID}	Differential input voltage	Receiver				±12	V
	Lligh lovel output ourrent	Driver				40	mA
IOH	High-level output current	Receiver				-400	μΑ
	Lavelaval autout avenue	Driver				-40	A
I _{OL}	Low-level output current	Receiver				16	mA
T _A	Operating free-air temperature			-20		85	°C

⁽¹⁾ Refer to TIA/EIA-422-B for exact conditions.

DRIVER SECTION

Electrical Characteristics

over recommended supply voltage and operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST	CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT	
V _{OH}	High-level output voltage	V _{IH} = 2 V, V _{IL} = 0	V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -20 mA				V	
V _{OL}	Low-level output voltage	V _{IH} = 2 V, V _{IL} = 0	0.8 V, I _{OL} = 20 mA		1.1		V	
V _{OD1}	Differential output voltage	$I_O = 0 \text{ mA}$		1.5		6	V	
V_{OD2}	Differential output voltage ⁽²⁾	$R_L = 100 \Omega$,	See Figure 1	2			V	
ΔV_{OD}	Change in magnitude of differential output voltage (2)	$R_L = 100 \Omega$,	See Figure 1			±0.4	V	
V _{oc}	Common-mode output voltage ⁽²⁾	$R_L = 100 \Omega$,	See Figure 1			±3	V	
ΔV _{OC}	Change in magnitude of differential common-mode voltage (2)	$R_L = 100 \Omega$,	See Figure 1			±0.4	V	
	0.1	V 0 V	V _O = 6 V			100	^	
I _{off}	Output current with power off ⁽²⁾	$V_{CC} = 0 V$	V _O = -0.25 V			-100	μA	
l _{OZ}	High-impedance-state output current	$V_0 = -0.25 \text{ V to}$	6 V			±100	μΑ	
I _{IH}	High-level input current	V _I = 2.7 V				20	μΑ	
I _{IL}	Low-level input current	V _I = 0.4 V				-100	μΑ	
los	Short-circuit output current ⁽²⁾ (3)	$V_O = V_{CC}$ or GNI)	-30		-150	mA	
	Complex compact (total and long)	Nalaad	Output enabled		80	110	A	
I _{CC}	Supply current (total package)	No load	Output disabled		50	80	mA	

All typical values are at V_{CC} = 5 V and T_A = 25 °C. Refer to TIA-EIA-422-B for exact conditions.

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Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



Switching Characteristics

 $V_{CC} = 5 \text{ V}, C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{d(OD)}	Differential output delay time	$R_L = 100 \Omega$, $C_L = 50 pF$, See Figure 3		20	25	ns
$t_{t(OD)}$	Differential output transition time	$R_L = 100 \Omega$, $C_L = 50 pF$, See Figure 3		27	35	ns
t _{PLH}	Propagation delay time, low- to high-level output	$R_L = 27 \Omega$, See Figure 4		20	25	ns
t _{PHL}	Propagation delay time, high- to low-level output	$R_L = 27 \Omega$, See Figure 4		20	25	ns
t _{PZH}	Output enable time to high level	$R_L = 110 \Omega$, See Figure 5		80	120	ns
t _{PZL}	Output enable time to low level	$R_L = 110 \Omega$, See Figure 6		40	60	ns
t _{PHZ}	Output disable time from high level	$R_L = 110 \Omega$, See Figure 5		90	120	ns
t _{PLZ}	Output disable time from low level	$R_L = 110 \Omega$, See Figure 6		30	45	ns

RECEIVER SECTION

Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
V _{IT+}	Positive-going input threshold voltage, dif					0.2	V	
V_{IT-}	Negative-going input threshold voltage, d	ifferential input			-0.2 ⁽²⁾			V
V_{hys}	Input hysteresis (V _{IT+} - V _{IT-})					50		mV
V _{IK}	Input clamp voltage, RE	SN7534050	I _I = -18 mA				-1.5	V
V _{OH}	High-level output voltage		V _{ID} = 200 mV, I _{OH} = -400 μA,	See Figure 2	2.7			V
V	Low lovel output voltage		$V_{ID} = -200 \text{ mV},$	$I_{OL} = 8 \text{ mA}$			0.45	V
V _{OL}	Low-level output voltage		See Figure 2	$I_{OL} = 16 \text{ mA}$			0.5	v
I _{OZ}	High-impedance-state output current	SN7534050	V _O = 0.4 V to 2.4 V				±20	μA
	Line toward comment	·	Other leaves of O.V.	V _I = 10 V			1.5	
I _I	Line input current		Other input at 0 V	V _I = -10 V			-2.5	mA
I _{IH}	High-level enable input current, RE	SN7534050	V _{IH} = 2.7 V				20	μA
I _{IL}	Low-level enable input current, RE	SN7534050	V _{IL} = 0.4 V				-100	μA
ri	Input resistance				12			kΩ
los	Short circuit output current				-15		-85	mA
I_{CC}	Supply current (total package)		No load, enabled			80	110	mA

Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low- to high-le	V_{ID} = 1.5 V, C_L = 15 pF, See Figure 7		20	35	ns	
t _{PHL}	Propagation delay time, high- to low-le	evel output	$V_{ID} = 1.5 \text{ V}, C_L = 15 \text{ pF},$ See Figure 7		22	35	ns
t _{PZH}	Output enable time to high level	SN7534050	C _L = 15 pF, see Figure 8		17	25	ns
t_{PZL}	Output enable time to low level	SN7534050	C _L = 15 pF, See Figure 8		20	27	ns
t _{PHZ}	Z Output disable time from high level SN7534050		C _L = 15 pF, See Figure 8		25	40	ns
t _{PLZ}	Output disable time from low level	C _L = 15 pF, See Figure 8		30	40	ns	

All typical values are at $V_{CC} = 5$ V and $T_A = 25$ °C. The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels.



PARAMETER MEASUREMENT INFORMATION

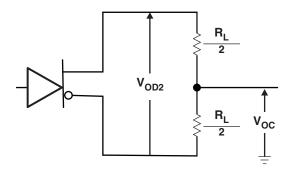


Figure 1. Driver Test Circuit, V_{OD} and V_{OC}

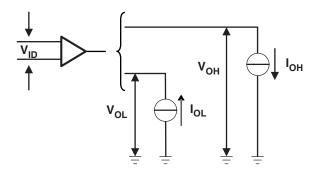


Figure 2. Receiver Test Circuit, V_{OH} and V_{OL}

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.

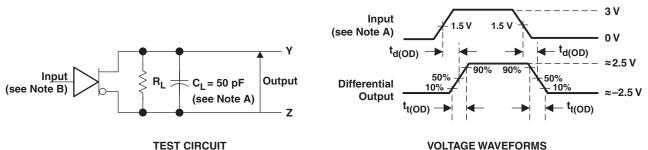


Figure 3. Driver Test Circuit and Voltage Waveforms, $t_{\text{d(OD)}}$ and $t_{\text{t(OD)}}$

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.



PARAMETER MEASUREMENT INFORMATION (continued)

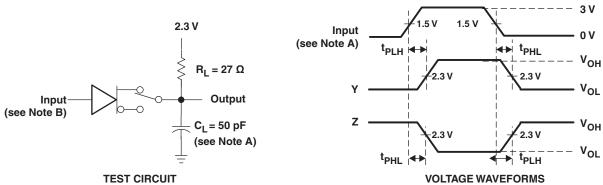


Figure 4. Driver Test Circuit and Voltage Waveforms, t_{PLH} and t_{PHL}

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.

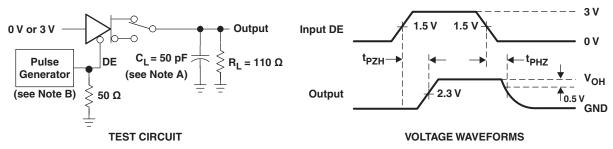


Figure 5. Driver Test Circuit and Voltage Waveforms, $$t_{\mbox{\scriptsize PZH}}$$ and $$t_{\mbox{\scriptsize PHZ}}$$

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.

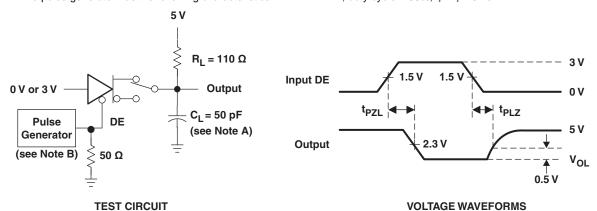


Figure 6. Driver Test Circuit and Voltage Waveforms, t_{PZL} and t_{PLZ}

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.



PARAMETER MEASUREMENT INFORMATION (continued)

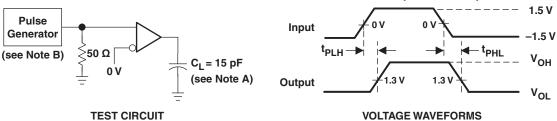
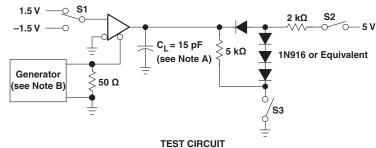
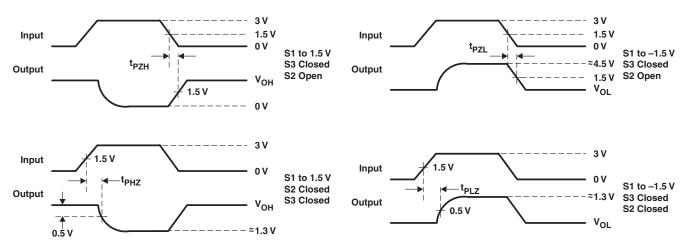


Figure 7. Receiver Test Circuit and Voltage Waveforms, $$t_{\rm PLH}$$ and $$t_{\rm PHL}$$

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_r = t_r \leq$ 6 ns.





VOLTAGE WAVEFORMS

Figure 8. Receiver Test Circuit and Voltage Waveforms, t_{PZH}, t_{PZL}, t_{PHZ}, t_{PLZ} (SN7534050)

SLLS833A -MAY 2007-REVISED APRIL 2013



REVISION HISTORY

Cł	hanges from Original (May 2007) to Revision A	Page
•	Updated document format from QS to DocZone.	1
•	Updated ORDERING INFORMATION table.	1





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN7534050N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 85	SN7534050N	Samples
SN7534050NS	ACTIVE	SO	NS	16	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-25 to 85	SN7534050	Samples
SN7534050NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-20 to 85	SN7534050	Samples
SN7534051N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 85	SN7534051N	Samples
SN7534051NS	ACTIVE	SO	NS	16	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-20 to 85	SN7534051	Samples
SN7534051NSR	ACTIVE	so	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-20 to 85	SN7534051	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

10-Dec-2020

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN7534050NSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN7534051NSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN7534050NSR	SO	NS	16	2000	356.0	356.0	35.0
SN7534051NSR	SO	NS	16	2000	356.0	356.0	35.0

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Jun-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN7534050N	N	PDIP	16	25	506	13.97	11230	4.32
SN7534050NS	NS	SOP	16	50	530	10.5	4000	4.1
SN7534051N	N	PDIP	16	25	506	13.97	11230	4.32
SN7534051NS	NS	SOP	16	50	530	10.5	4000	4.1



SOP



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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